

# ANTREX Electronics

Electronic Components Sourcing Information

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## Product Reference Information

**Part Number:** ADS8401IPFBT  
**Manufacturer:** Texas Instruments  
**Package:** 48-TQFP  
**Availability:** Please confirm with sales

**Product Page:**

<https://antrexco.com/product/details/texas-instruments/ads8401ipfbt.html>

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## Contact Information

Email: [info@antrexco.com](mailto:info@antrexco.com)

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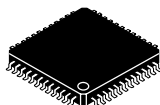
CoC / RoHS / REACH documents available on request

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**Note:**

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.



## 16-BIT, 1.25 MSPS, UNIPOLAR INPUT, MICRO POWER SAMPLING ANALOG-TO-DIGITAL CONVERTER WITH PARALLEL INTERFACE AND REFERENCE

### FEATURES

- 1.25-MHz Sample Rate
- 16-Bit NMC Ensured Over Temperature
- Zero Latency
- Unipolar Single-Ended Input Range: 0 V to  $V_{ref}$
- Onboard Reference
- Onboard Reference Buffer
- High-Speed Parallel Interface
- Power Dissipation: 155 mW at 1.25 MHz Typ
- Wide Digital Supply
- 8-/16-Bit Bus Transfer
- 48-Pin TQFP Package

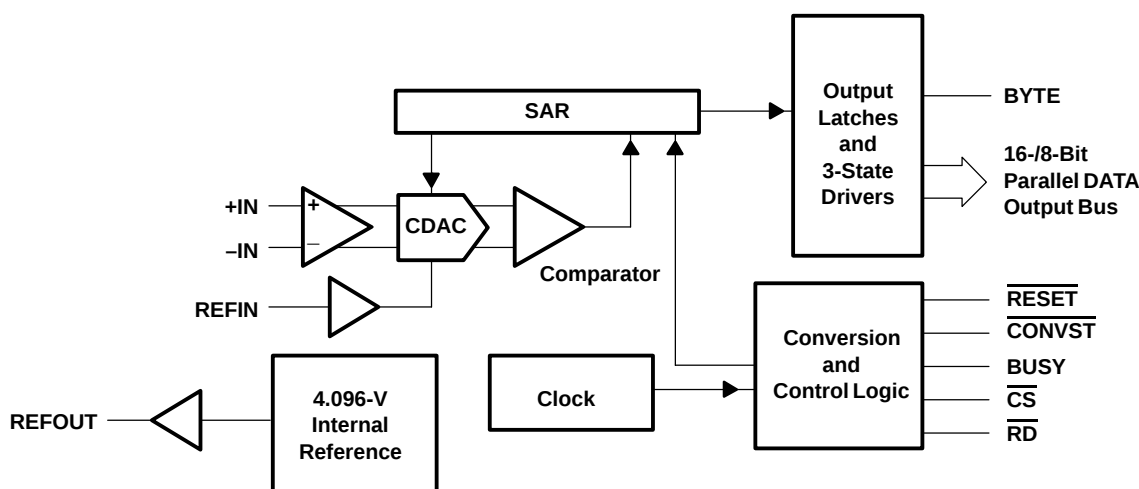
### APPLICATIONS

- DWDM
- Instrumentation
- High-Speed, High-Resolution, Zero Latency Data Acquisition Systems
- Transducer Interface
- Medical Instruments
- Communication

### DESCRIPTION

The ADS8401 is a 16-bit, 1.25 MHz A/D converter with an internal 4.096-V reference. The device includes a 16-bit capacitor-based SAR A/D converter with inherent sample and hold. The ADS8401 offers a full 16-bit interface and an 8-bit option where data is read using two 8-bit read cycles.

The ADS8401 has a unipolar single-ended input. It is available in a 48-lead TQFP package and is characterized over the industrial  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$  temperature range.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## ORDERING INFORMATION

| MODEL     | MAXIMUM INTEGRAL LINEARITY (LSB) | MAXIMUM DIFFERENTIAL LINEARITY (LSB) | NO MISSING CODES RESOLUTION (BIT) | PACKAGE TYPE | PACKAGE DESIGNATOR | TEMPERATURE RANGE | ORDERING INFORMATION | TRANSPORT MEDIA QUANTITY |
|-----------|----------------------------------|--------------------------------------|-----------------------------------|--------------|--------------------|-------------------|----------------------|--------------------------|
| ADS8401I  | ±6                               | –2~3                                 | 15                                | 48 Pin TQFP  | PFB                | –40°C to 85°C     | ADS8401IPFBT         | Tape and reel 250        |
|           |                                  |                                      |                                   |              |                    |                   | ADS8401IPFBR         | Tape and reel 1000       |
| ADS8401IB | ±3.5                             | –1~2                                 | 16                                | 48 Pin TQFP  | PFB                | –40°C to 85°C     | ADS8401IBPFBT        | Tape and reel 250        |
|           |                                  |                                      |                                   |              |                    |                   | ADS8401IBPFBR        | Tape and reel 1000       |

NOTE: For the most current specifications and package information, refer to our website at [www.ti.com](http://www.ti.com).

## ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted<sup>(1)</sup>

|                                                      |                                   | UNIT                                                   |
|------------------------------------------------------|-----------------------------------|--------------------------------------------------------|
| Voltage                                              | +IN to AGND                       | +VA + 0.1 V                                            |
|                                                      | –IN to AGND                       | 0.5 V                                                  |
| Voltage range                                        | +VA to AGND                       | –0.3 V to 7 V                                          |
|                                                      | +VBD to BDGND                     | –0.3 V to 7 V                                          |
|                                                      | +VA to +VBD                       | –0.3 V to 2.5 V                                        |
| Digital input voltage to BDGND                       |                                   | –0.3 V to +VBD + 0.3 V                                 |
| Digital output voltage to BDGND                      |                                   | –0.3 V to +VBD + 0.3 V                                 |
| Operating free-air temperature range, T <sub>A</sub> |                                   | –40°C to 85°C                                          |
| Storage temperature range, T <sub>stg</sub>          |                                   | –65°C to 150°C                                         |
| Junction temperature (T <sub>J</sub> max)            |                                   | 150°C                                                  |
| TQFP package                                         | Power dissipation                 | (T <sub>J</sub> Max – T <sub>A</sub> )/θ <sub>JA</sub> |
|                                                      | θ <sub>JA</sub> thermal impedance | 86°C/W                                                 |
| Lead temperature, soldering                          | Vapor phase (60 sec)              | 215°C                                                  |
|                                                      | Infrared (15 sec)                 | 220°C                                                  |

(1) Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## SPECIFICATIONS

 $T_A = -40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ ,  $+V_A = 5\text{ V}$ ,  $+V_{BD} = 3\text{ V}$  or  $5\text{ V}$ ,  $V_{\text{ref}} = 4.096\text{ V}$ ,  $f_{\text{SAMPLE}} = 1.25\text{ MHz}$  (unless otherwise noted)

| PARAMETER                              |           | TEST CONDITIONS                                                                | MIN    | TYP   | MAX                    | UNIT   |
|----------------------------------------|-----------|--------------------------------------------------------------------------------|--------|-------|------------------------|--------|
| Analog Input                           |           |                                                                                |        |       |                        |        |
| Full-scale input voltage (see Note 1)  |           | +IN – –IN                                                                      | 0      |       | V <sub>ref</sub>       | V      |
| Absolute input voltage                 |           | +IN                                                                            | –0.2   |       | V <sub>ref</sub> + 0.2 | V      |
|                                        |           | –IN                                                                            | –0.2   |       | 0.2                    |        |
| Input capacitance                      |           |                                                                                |        | 25    |                        | pF     |
| Input leakage current                  |           |                                                                                |        | 0.5   |                        | nA     |
| System Performance                     |           |                                                                                |        |       |                        |        |
| Resolution                             |           |                                                                                |        | 16    |                        | Bits   |
| No missing codes                       | ADS8401I  |                                                                                |        | 15    |                        | Bits   |
|                                        | ADS8401IB |                                                                                |        | 16    |                        |        |
| Integral linearity (see Notes 2 and 3) | ADS8401I  |                                                                                | –6     | ±2.5  | 6                      | LSB    |
|                                        | ADS8401IB |                                                                                | –3.5   | ±2    | 3.5                    |        |
| Differential linearity                 | ADS8401I  |                                                                                | –2     | ±1    | 3                      | LSB    |
|                                        | ADS8401IB |                                                                                | –1     | ±0.75 | 2                      |        |
| Offset error (see Note 4)              | ADS8401I  |                                                                                | –1.5   | ±0.5  | 1.5                    | mV     |
|                                        | ADS8401IB |                                                                                | –0.75  | ±0.25 | 0.75                   | mV     |
| Gain error (see Notes 4 and 5)         | ADS8401I  |                                                                                | –0.15  |       | 0.15                   | %FS    |
|                                        | ADS8401IB |                                                                                | –0.098 |       | 0.098                  |        |
| Noise                                  |           |                                                                                |        | 60    |                        | μV RMS |
| DC Power supply rejection ratio        |           | At FFFFh output code,<br>+VA = 4.75 V to 5.25 V,<br>Vref = 4.096 V, See Note 4 |        | 2     |                        | LSB    |
| Sampling Dynamics                      |           |                                                                                |        |       |                        |        |
| Conversion time                        |           |                                                                                |        |       | 610                    | ns     |
| Acquisition time                       |           |                                                                                |        | 150   |                        | ns     |
| Throughput rate                        |           |                                                                                |        |       | 1.25                   | MHz    |
| Aperture delay                         |           |                                                                                |        | 2     |                        | ns     |
| Aperture jitter                        |           |                                                                                |        | 25    |                        | ps     |
| Step response                          |           |                                                                                |        | 100   |                        | ns     |
| Overvoltage recovery                   |           |                                                                                |        | 100   |                        | ns     |

(1) Ideal input span, does not include gain or offset error.

(2) LSB means least significant bit

(3) This is endpoint INL, not best fit.

(4) Measured relative to an ideal full-scale input ( $+IN - -IN$ ) of  $4.096\text{ V}$ 

(5) This specification does not include the internal reference voltage error and drift.

## SPECIFICATIONS (CONTINUED)

$T_A = -40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ ,  $+V_A = +5\text{ V}$ ,  $+V_{BD} = 3\text{ V}$  or  $5\text{ V}$ ,  $V_{\text{ref}} = 4.096\text{ V}$ ,  $f_{\text{SAMPLE}} = 1.25\text{ MHz}$  (unless otherwise noted)

| PARAMETER                                    |                                      | TEST CONDITIONS                                                     | MIN                    | TYP                    | MAX  | UNIT               |
|----------------------------------------------|--------------------------------------|---------------------------------------------------------------------|------------------------|------------------------|------|--------------------|
| <b>Dynamic Characteristics</b>               |                                      |                                                                     |                        |                        |      |                    |
| Total harmonic distortion (THD) (see Note 1) |                                      | $V_{\text{IN}} = 4\text{ V}_{\text{pp}}$ at 100 kHz                 |                        | –93                    |      | dB                 |
| Signal-to-noise ratio (SNR)                  |                                      | $V_{\text{IN}} = 4\text{ V}_{\text{pp}}$ at 100 kHz                 |                        | 86                     |      | dB                 |
| Signal-to-noise + distortion (SINAD)         |                                      | $V_{\text{IN}} = 4\text{ V}_{\text{pp}}$ at 100 kHz                 |                        | 85                     |      | dB                 |
| Spurious free dynamic range (SFDR)           |                                      | $V_{\text{IN}} = 4\text{ V}_{\text{pp}}$ at 100 kHz                 |                        | 93                     |      | dB                 |
| –3dB Small signal bandwidth                  |                                      |                                                                     |                        | 5                      |      | MHz                |
| <b>External Voltage Reference Input</b>      |                                      |                                                                     |                        |                        |      |                    |
| Reference voltage at REFIN, $V_{\text{ref}}$ |                                      |                                                                     | 2.5                    | 4.096                  | 4.2  | V                  |
| Reference resistance (see Note 2)            |                                      |                                                                     |                        | 500                    |      | k $\Omega$         |
| <b>Internal Reference Output</b>             |                                      |                                                                     |                        |                        |      |                    |
| Internal reference start-up time             |                                      | from 95% (+V <sub>A</sub> ), with 1 $\mu\text{F}$ storage capacitor |                        |                        | 120  | ms                 |
| $V_{\text{ref}}$ range                       |                                      | I <sub>OUT</sub> = 0                                                | 4.065                  | 4.096                  | 4.13 | V                  |
| <b>Source Current</b>                        |                                      | Static load                                                         |                        |                        | 10   | $\mu\text{A}$      |
| <b>Line Regulation</b>                       |                                      | +V <sub>A</sub> = 4.75 ~ 5.25 V                                     |                        | 0.6                    |      | mV                 |
| Drift                                        |                                      | I <sub>OUT</sub> = 0                                                |                        | 36                     |      | PPM/C              |
| <b>Digital Input/Output</b>                  |                                      |                                                                     |                        |                        |      |                    |
| Logic family                                 |                                      |                                                                     |                        | CMOS                   |      |                    |
| Logic level                                  | $V_{\text{IH}}$                      | I <sub>IH</sub> = 5 $\mu\text{A}$                                   | +V <sub>BD</sub> –1    | +V <sub>BD</sub> + 0.3 |      | V                  |
|                                              | $V_{\text{IL}}$                      | I <sub>IL</sub> = 5 $\mu\text{A}$                                   | –0.3                   | 0.8                    |      |                    |
|                                              | $V_{\text{OH}}$                      | I <sub>OH</sub> = 2 TTL loads                                       | +V <sub>BD</sub> – 0.6 | +V <sub>BD</sub>       |      |                    |
|                                              | $V_{\text{OL}}$                      | I <sub>OL</sub> = 2 TTL loads                                       | 0                      | 0.4                    |      |                    |
| Data format                                  |                                      |                                                                     |                        | Straight Binary        |      |                    |
| <b>Power Supply Requirements</b>             |                                      |                                                                     |                        |                        |      |                    |
| Power supply voltage                         | +V <sub>BD</sub> (see Notes 3 and 4) |                                                                     | 2.95                   | 3.3                    | 5.25 | V                  |
|                                              | +V <sub>A</sub> (see Note 4)         |                                                                     | 4.75                   | 5                      | 5.25 | V                  |
| +V <sub>A</sub> Supply current (see Note 5)  |                                      | $f_S = 1.25\text{ MHz}$                                             |                        | 31                     | 34   | mA                 |
| Power dissipation (see Note 5)               |                                      | $f_S = 1.25\text{ MHz}$                                             |                        | 155                    |      | mW                 |
| <b>Temperature Range</b>                     |                                      |                                                                     |                        |                        |      |                    |
| Operating free-air                           |                                      |                                                                     | –40                    |                        | 85   | $^{\circ}\text{C}$ |

(1) Calculated on the first nine harmonics of the input frequency

(2) Can vary  $\pm 20\%$

(3) The difference between +V<sub>A</sub> and +V<sub>BD</sub> should not be less than 2.3 V, i.e., if +V<sub>A</sub> is 5.25 V, +V<sub>BD</sub> should be minimum of 2.95 V.

(4) +V<sub>BD</sub>  $\geq$  +V<sub>A</sub> – 2.3 V

(5) This includes only V<sub>A</sub>+ current. +V<sub>BD</sub> current is typically 1 mA with 5 pF load capacitance on output pins.

## TIMING CHARACTERISTICS

All specifications typical at  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ ,  $+V_A = +V_{BD} = 5\text{ V}$  (see Notes 1, 2, and 3)

| PARAMETER         |                                                                                                                                                                                          | MIN                          | TYP | MAX | UNIT |
|-------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------|-----|-----|------|
| $t_{\text{CONV}}$ | Conversion time                                                                                                                                                                          |                              | 600 | 610 | ns   |
| $t_{\text{ACQ}}$  | Acquisition time                                                                                                                                                                         | 150                          |     |     | ns   |
| $t_{\text{pd1}}$  | $\overline{\text{CONVST}}$ low to conversion started (BUSY high)                                                                                                                         |                              |     | 35  | ns   |
| $t_{\text{pd2}}$  | Propagation delay time, End of conversion to BUSY low                                                                                                                                    |                              |     | 20  | ns   |
| $t_{\text{w1}}$   | Pulse duration, $\overline{\text{CONVST}}$ low                                                                                                                                           | 20                           |     |     | ns   |
| $t_{\text{su1}}$  | Setup time, $\overline{\text{CS}}$ low to $\overline{\text{CONVST}}$ low                                                                                                                 | 0                            |     |     | ns   |
| $t_{\text{w2}}$   | Pulse duration, $\overline{\text{CONVST}}$ high                                                                                                                                          | 20                           |     |     | ns   |
|                   | $\overline{\text{CONVST}}$ falling edge jitter                                                                                                                                           |                              |     | 10  | ps   |
| $t_{\text{w3}}$   | Pulse duration, BUSY signal low                                                                                                                                                          | $\text{Min}(t_{\text{ACQ}})$ |     |     | ns   |
| $t_{\text{w4}}$   | Pulse duration, BUSY signal high                                                                                                                                                         |                              |     | 630 | ns   |
| $t_{\text{h1}}$   | Hold time, First <u>data bus</u> data transition ( $\overline{\text{RD}}$ low, or $\overline{\text{CS}}$ low for read cycle, or BYTE input changes) after $\overline{\text{CONVST}}$ low | 40                           |     |     | ns   |
| $t_{\text{d1}}$   | Delay time, $\overline{\text{CS}}$ low to $\overline{\text{RD}}$ low                                                                                                                     | 0                            |     |     | ns   |
| $t_{\text{su2}}$  | Setup time, $\overline{\text{RD}}$ high to $\overline{\text{CS}}$ high                                                                                                                   | 0                            |     |     | ns   |
| $t_{\text{w5}}$   | Pulse duration, $\overline{\text{RD}}$ low time                                                                                                                                          | 50                           |     |     | ns   |
| $t_{\text{en}}$   | Enable time, $\overline{\text{RD}}$ low (or $\overline{\text{CS}}$ low for read cycle) to data valid                                                                                     |                              |     | 20  | ns   |
| $t_{\text{d2}}$   | Delay time, data hold from $\overline{\text{RD}}$ high                                                                                                                                   | 0                            |     |     | ns   |
| $t_{\text{d3}}$   | Delay time, BYTE rising edge or falling edge to data valid                                                                                                                               | 2                            |     | 20  | ns   |
| $t_{\text{w6}}$   | $\overline{\text{RD}}$ high                                                                                                                                                              | 20                           |     |     | ns   |
| $t_{\text{h2}}$   | Hold time, last $\overline{\text{RD}}$ (or $\overline{\text{CS}}$ for read cycle) rising edge to $\overline{\text{CONVST}}$ falling edge                                                 | 50                           |     |     | ns   |
| $t_{\text{pd4}}$  | Propagation delay time, BUSY falling edge to next $\overline{\text{RD}}$ (or $\overline{\text{CS}}$ for read cycle) falling edge                                                         | $\text{Max}(t_{\text{d5}})$  |     |     | ns   |
| $t_{\text{su3}}$  | Setup time, BYTE rising edge to $\overline{\text{RD}}$ falling edge                                                                                                                      | 0                            |     |     | ns   |
| $t_{\text{h3}}$   | Hold time, BYTE falling edge to $\overline{\text{RD}}$ falling edge                                                                                                                      | 0                            |     |     | ns   |
| $t_{\text{dis}}$  | Disable time, $\overline{\text{RD}}$ High ( $\overline{\text{CS}}$ high for read cycle) to 3-stated data bus                                                                             |                              |     | 20  | ns   |
| $t_{\text{d5}}$   | Delay time, BUSY low to MSB data valid                                                                                                                                                   |                              |     | 0   | ns   |
| $t_{\text{su4}}$  | Setup time, BYTE change before BUSY falling edge                                                                                                                                         | 2                            |     | 20  | ns   |

(1) All input signals are specified with  $t_r = t_f = 5\text{ ns}$  (10% to 90% of  $+V_{BD}$ ) and timed from a voltage level of  $(V_{\text{IL}} + V_{\text{IH}})/2$ .

(2) See timing diagrams.

(3) All timings are measured with 20 pF equivalent loads on all data bits and BUSY pins.

**TIMING CHARACTERISTICS**

All specifications typical at –40°C to 85°C, +VA = 5 V, +VBD = 3 V (see Notes 1, 2, and 3)

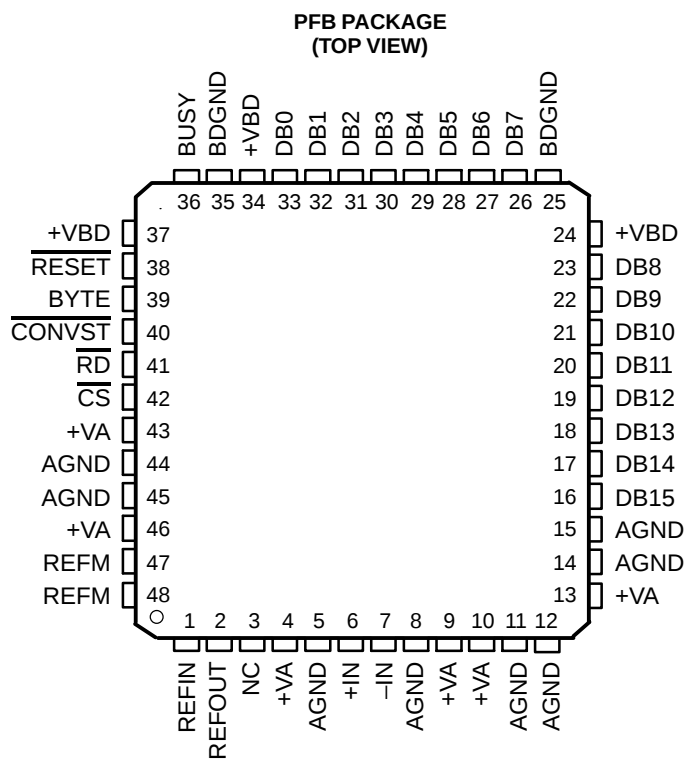
| PARAMETER         |                                                                                                                              | MIN                    | TYP | MAX | UNIT |
|-------------------|------------------------------------------------------------------------------------------------------------------------------|------------------------|-----|-----|------|
| t <sub>CONV</sub> | Conversion time                                                                                                              |                        | 600 | 610 | ns   |
| t <sub>ACQ</sub>  | Acquisition time                                                                                                             | 150                    |     |     | ns   |
| t <sub>pd1</sub>  | CONVST low to conversion started (BUSY high)                                                                                 |                        |     | 40  | ns   |
| t <sub>pd2</sub>  | Propagation delay time, end of conversion to BUSY low                                                                        |                        |     | 20  | ns   |
| t <sub>w1</sub>   | Pulse duration, CONVST low                                                                                                   | 20                     |     |     | ns   |
| t <sub>su1</sub>  | Setup time, CS low to CONVST low                                                                                             | 0                      |     |     | ns   |
| t <sub>w2</sub>   | Pulse duration, CONVST high                                                                                                  | 20                     |     |     | ns   |
|                   | CONVST falling edge jitter                                                                                                   |                        |     | 10  | ps   |
| t <sub>w3</sub>   | Pulse duration, BUSY signal low                                                                                              | Min(t <sub>ACQ</sub> ) |     |     | ns   |
| t <sub>w4</sub>   | Pulse duration, BUSY signal high                                                                                             |                        |     | 630 | ns   |
| t <sub>h1</sub>   | Hold time, first data bus transition (RD low, or CS low for read cycle, or BYTE or BUS 16/16 input changes) after CONVST low | 40                     |     |     | ns   |
| t <sub>d1</sub>   | Delay time, CS low to RD low                                                                                                 | 0                      |     |     | ns   |
| t <sub>su2</sub>  | Setup time, RD high to CS high                                                                                               | 0                      |     |     | ns   |
| t <sub>w5</sub>   | Pulse duration, RD low                                                                                                       | 50                     |     |     | ns   |
| t <sub>en</sub>   | Enable time, RD low (or CS low for read cycle) to data valid                                                                 |                        |     | 30  | ns   |
| t <sub>d2</sub>   | Delay time, data hold from RD high                                                                                           | 0                      |     |     | ns   |
| t <sub>d3</sub>   | Delay time, BUS16/16 or BYTE rising edge or falling edge to data valid                                                       | 2                      |     | 30  | ns   |
| t <sub>w6</sub>   | Pulse duration, RD high time                                                                                                 | 20                     |     |     | ns   |
| t <sub>h2</sub>   | Hold time, last RD (or CS for read cycle) rising edge to CONVST falling edge                                                 | 50                     |     |     | ns   |
| t <sub>pd4</sub>  | Propagation delay time, BUSY falling edge to next RD (or CS for read cycle) falling edge                                     | Max(t <sub>d5</sub> )  |     |     | ns   |
| t <sub>su3</sub>  | Setup time, BYTE rising edge to RD falling edge                                                                              | 0                      |     |     | ns   |
| t <sub>h3</sub>   | Hold time, BYTE falling edge to RD falling edge                                                                              | 0                      |     |     | ns   |
| t <sub>dis</sub>  | Disable time, RD High (CS high for read cycle) to 3-stated data bus                                                          |                        |     | 30  | ns   |
| t <sub>d5</sub>   | Delay time, BUSY low to MSB data valid delay time                                                                            |                        |     | 0   | ns   |
| t <sub>su4</sub>  | Setup time, BYTE change before BUSY falling edge                                                                             | 2                      |     | 30  | ns   |

(1) All input signals are specified with t<sub>r</sub> = t<sub>f</sub> = 5 ns (10% to 90% of +VBD) and timed from a voltage level of (V<sub>IL</sub> + V<sub>IH</sub>)/2.

(2) See timing diagrams.

(3) All timings are measured with 10 pF equivalent loads on all data bits and BUSY pins.

## PIN ASSIGNMENTS

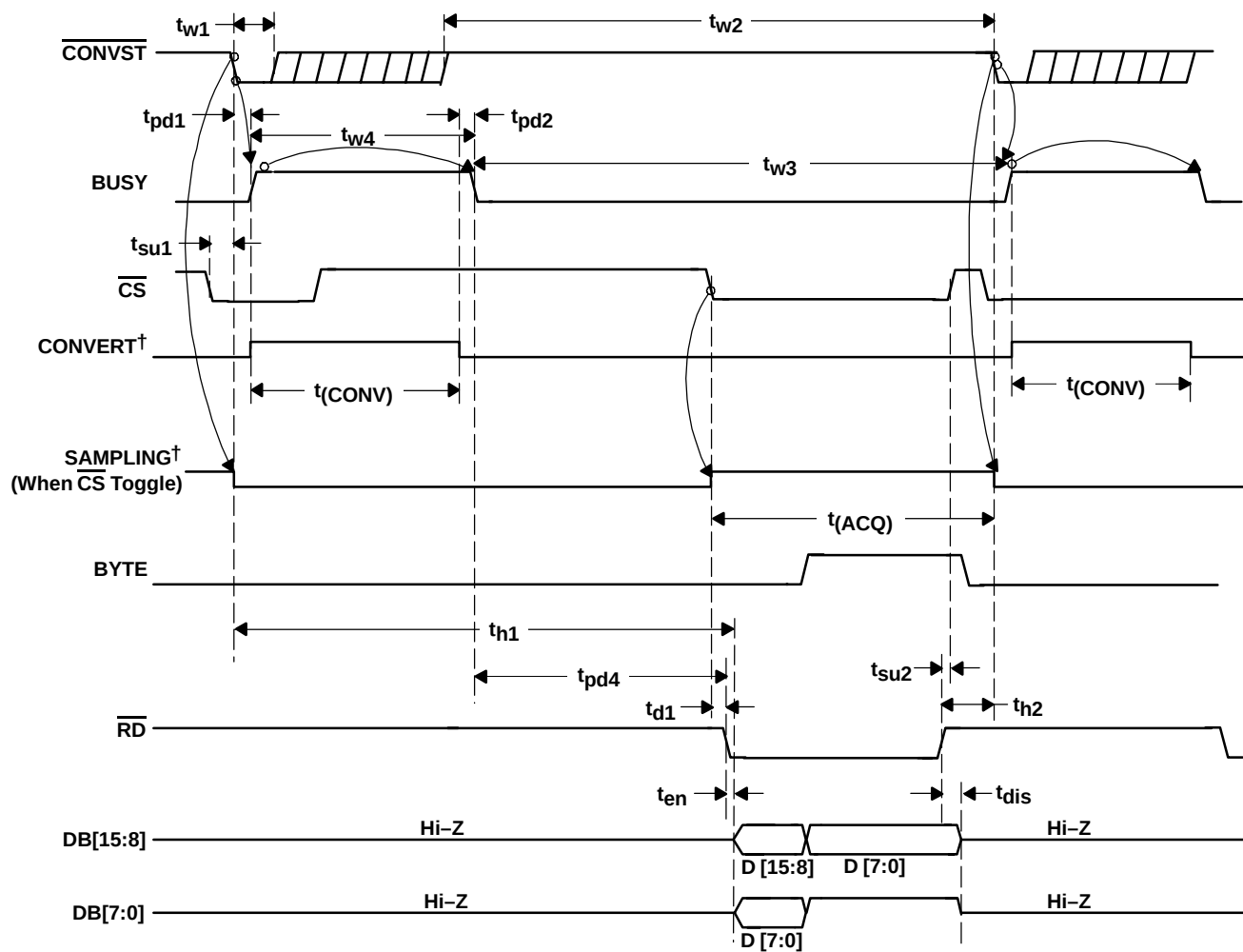


NC – No connection

**TERMINAL FUNCTIONS**

| NAME     | NO.                             | I/O | DESCRIPTION                                                                                                                                                                                   |          |            |
|----------|---------------------------------|-----|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|------------|
| AGND     | 5, 8, 11, 12,<br>14, 15, 44, 45 | –   | Analog ground                                                                                                                                                                                 |          |            |
| BDGND    | 25, 35                          | –   | Digital ground for bus interface digital supply                                                                                                                                               |          |            |
| BUSY     | 36                              | O   | Status output. High when a conversion is in progress.                                                                                                                                         |          |            |
| BYTE     | 39                              | I   | Byte select input. Used for 8-bit bus reading.<br>0: No fold back<br>1: Low byte D[7:0] of the 16 most significant bits is folded back to high byte of the 16 most significant pins DB[15:8]. |          |            |
| CONVST   | 40                              | I   | Convert start                                                                                                                                                                                 |          |            |
| CS       | 42                              | I   | Chip select                                                                                                                                                                                   |          |            |
| Data Bus |                                 |     | 8-Bit Bus                                                                                                                                                                                     |          | 16-Bit Bus |
|          |                                 |     | BYTE = 0                                                                                                                                                                                      | BYTE = 1 | BYTE = 0   |
| DB15     | 16                              | O   | D15 (MSB)                                                                                                                                                                                     | D7       | D15 (MSB)  |
| DB14     | 17                              | O   | D14                                                                                                                                                                                           | D6       | D14        |
| DB13     | 18                              | O   | D13                                                                                                                                                                                           | D5       | D13        |
| DB12     | 19                              | O   | D12                                                                                                                                                                                           | D4       | D12        |
| DB11     | 20                              | O   | D11                                                                                                                                                                                           | D3       | D11        |
| DB10     | 21                              | O   | D10                                                                                                                                                                                           | D2       | D10        |
| DB9      | 22                              | O   | D9                                                                                                                                                                                            | D1       | D9         |
| DB8      | 23                              | O   | D8                                                                                                                                                                                            | D0 (LSB) | D8         |
| DB7      | 26                              | O   | D7                                                                                                                                                                                            | All ones | D7         |
| DB6      | 27                              | O   | D6                                                                                                                                                                                            | All ones | D6         |
| DB5      | 28                              | O   | D5                                                                                                                                                                                            | All ones | D5         |
| DB4      | 29                              | O   | D4                                                                                                                                                                                            | All ones | D4         |
| DB3      | 30                              | O   | D3                                                                                                                                                                                            | All ones | D3         |
| DB2      | 31                              | O   | D2                                                                                                                                                                                            | All ones | D2         |
| DB1      | 32                              | O   | D1                                                                                                                                                                                            | All ones | D1         |
| DB0      | 33                              | O   | D0 (LSB)                                                                                                                                                                                      | All ones | D0 (LSB)   |
| –IN      | 7                               | I   | Inverting input channel                                                                                                                                                                       |          |            |
| +IN      | 6                               | I   | Non inverting input channel                                                                                                                                                                   |          |            |
| NC       | 3                               | –   | No connection                                                                                                                                                                                 |          |            |
| REFIN    | 1                               | I   | Reference input                                                                                                                                                                               |          |            |
| REFM     | 47, 48                          | I   | Reference ground                                                                                                                                                                              |          |            |
| REFOUT   | 2                               | O   | Reference output. Add 1 $\mu$ F capacitor between the REFOUT pin and REFM pin when internal reference is used.                                                                                |          |            |
| RESET    | 38                              | I   | Current conversion is aborted and output latches are cleared (set to zeros) when this pin is asserted low. RESET works independantly of CS.                                                   |          |            |
| RD       | 41                              | I   | Synchronization pulse for the parallel output.                                                                                                                                                |          |            |
| +VA      | 4, 9, 10, 13,<br>43, 46         | –   | Analog power supplies, 5-V dc                                                                                                                                                                 |          |            |
| +VBD     | 24, 34, 37                      | –   | Digital power supply for bus                                                                                                                                                                  |          |            |

## TIMING DIAGRAMS



†Signal internal to device

Figure 1. Timing for Conversion and Acquisition Cycles With  $\overline{CS}$  and  $\overline{RD}$  Toggling

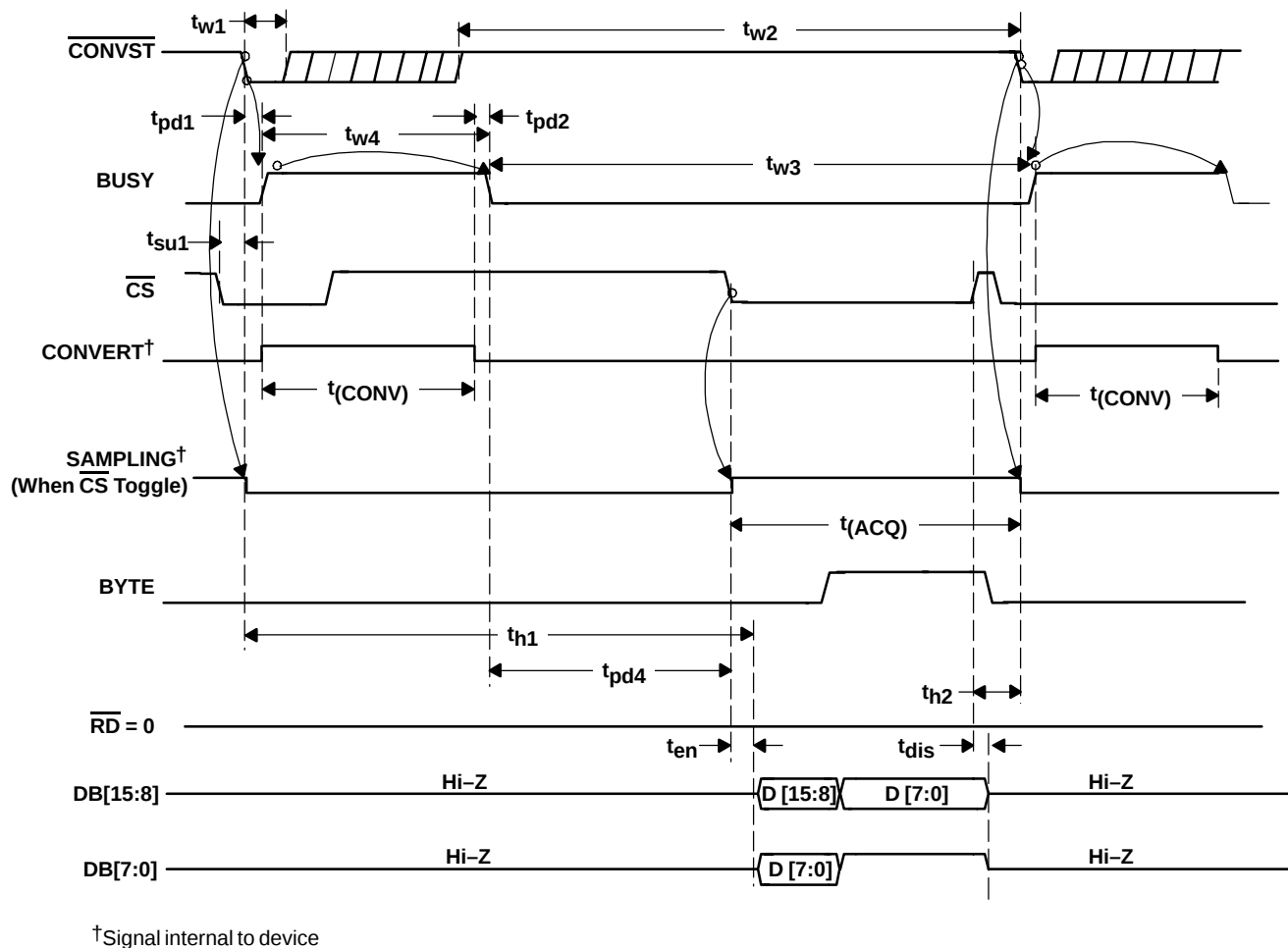
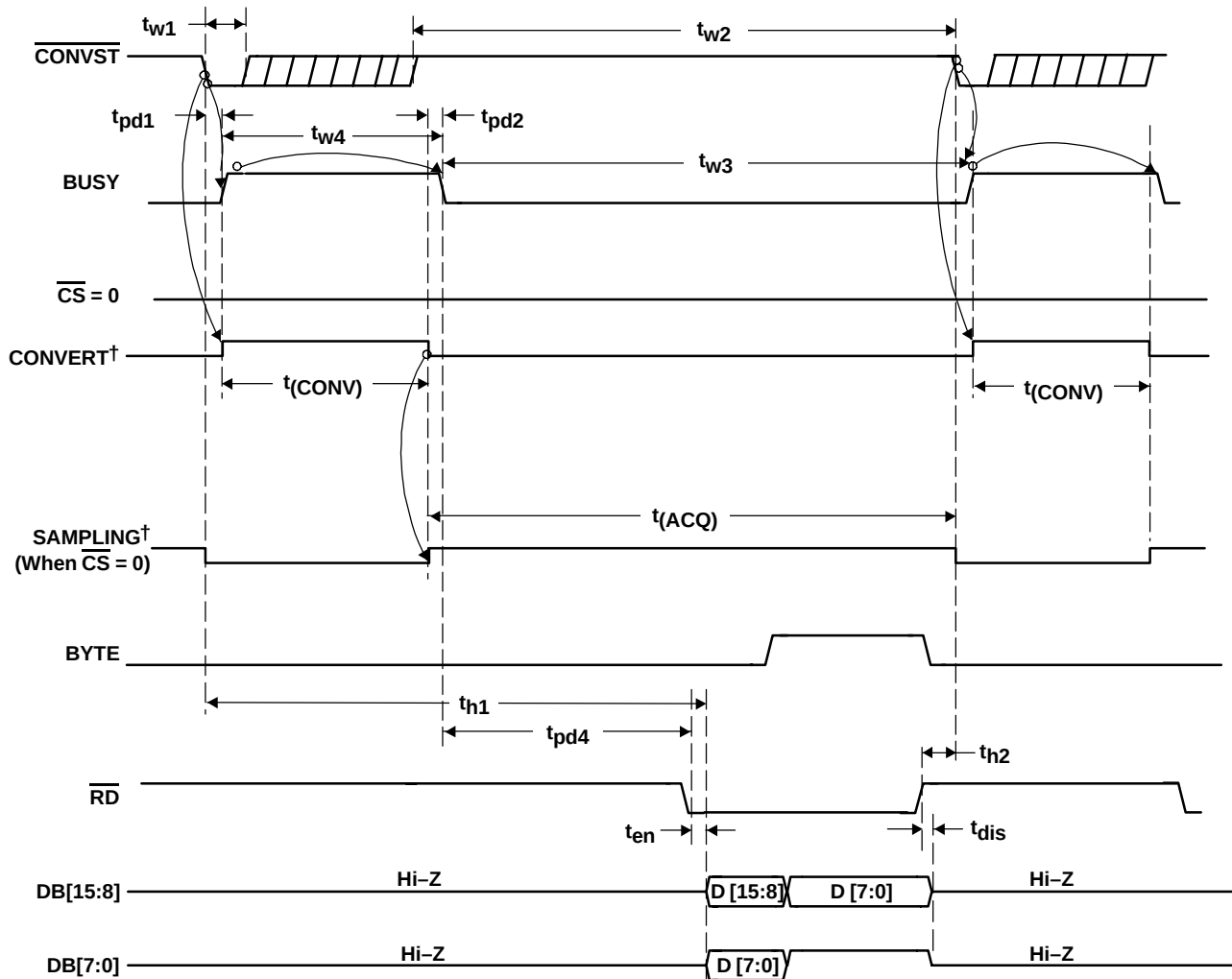
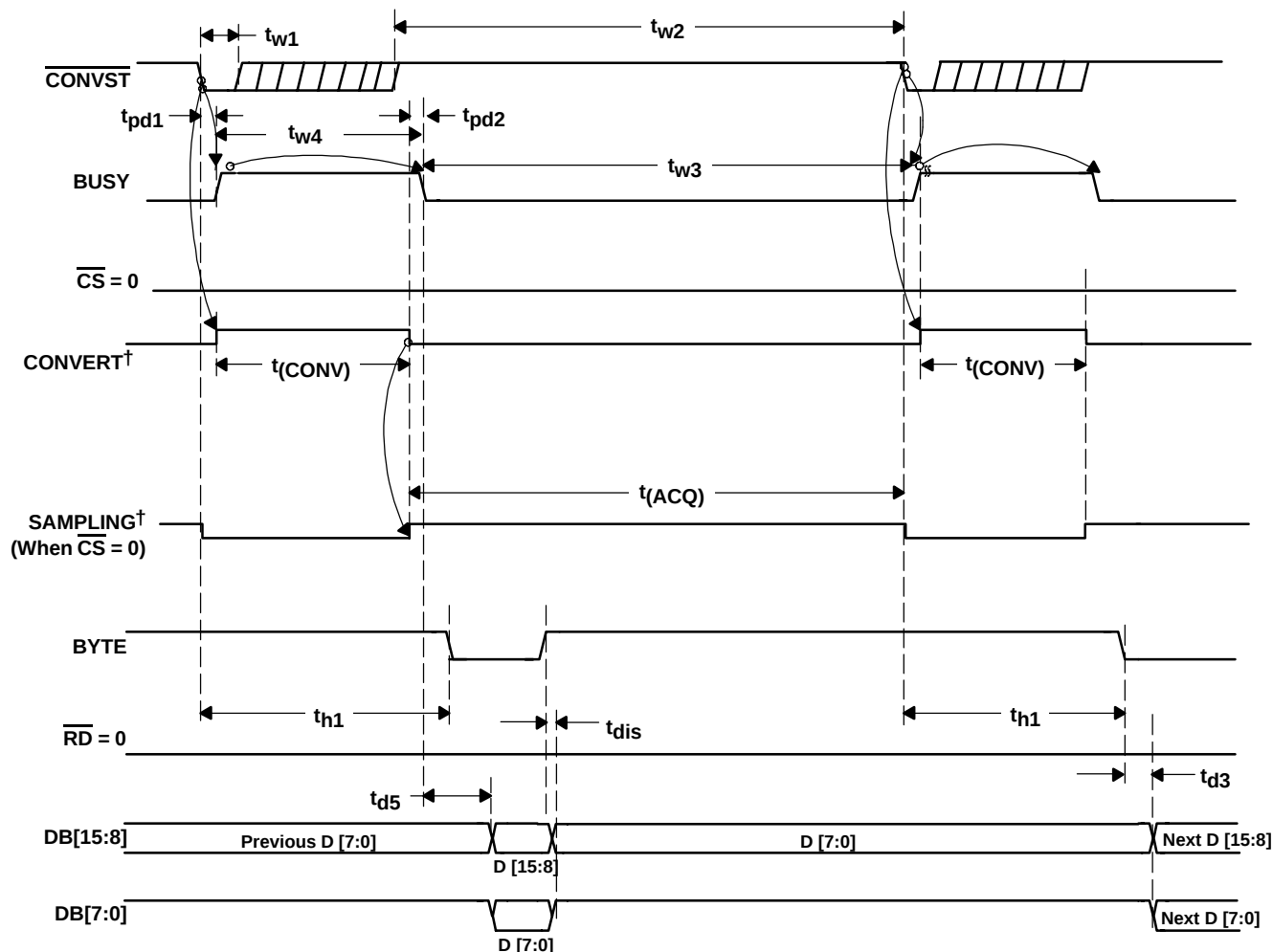


Figure 2. Timing for Conversion and Acquisition Cycles With  $\overline{\text{CS}}$  Toggling,  $\overline{\text{RD}}$  Tied to BDGND



†Signal internal to device

Figure 3. Timing for Conversion and Acquisition Cycles With  $\overline{CS}$  Tied to BDGND,  $\overline{RD}$  Toggling



$^\dagger$ Signal internal to device

Figure 4. Timing for Conversion and Acquisition Cycles With  $\overline{\text{CS}}$  and  $\overline{\text{RD}}$  Tied to BDGND—Auto Read

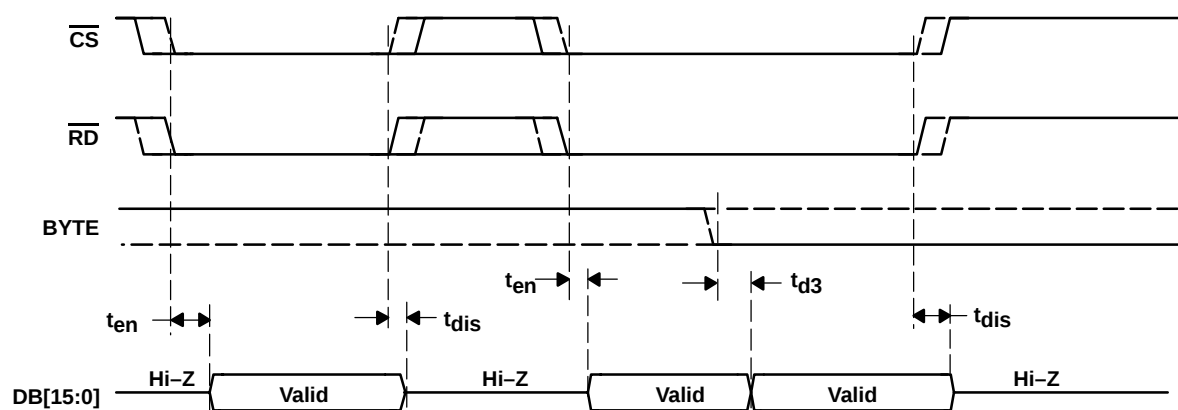
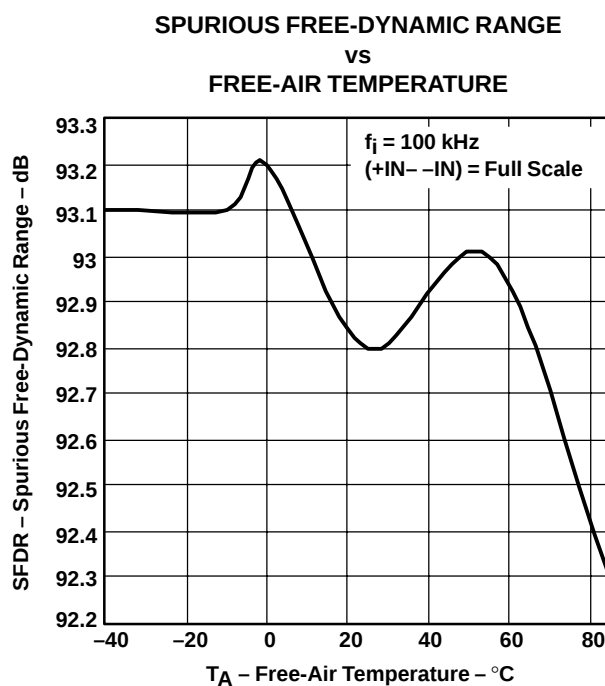
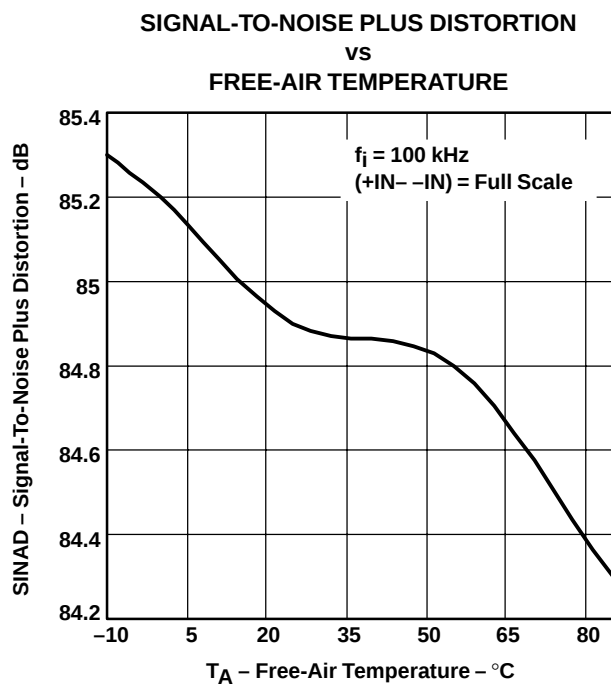
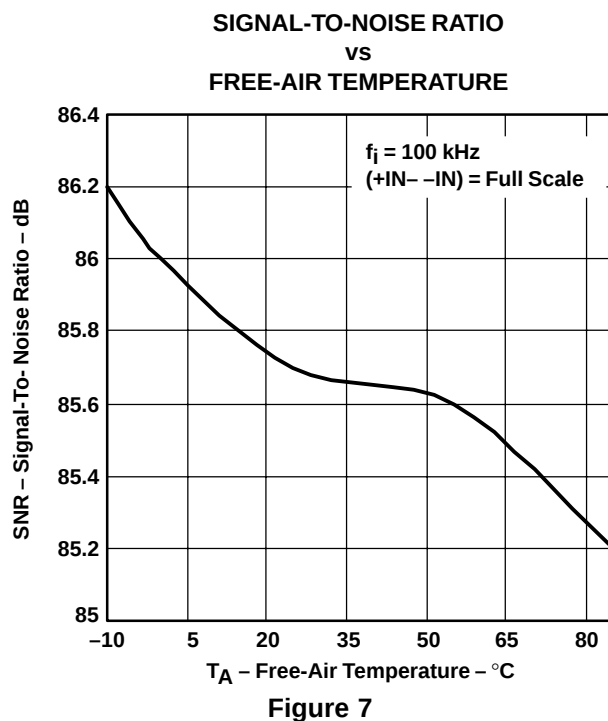
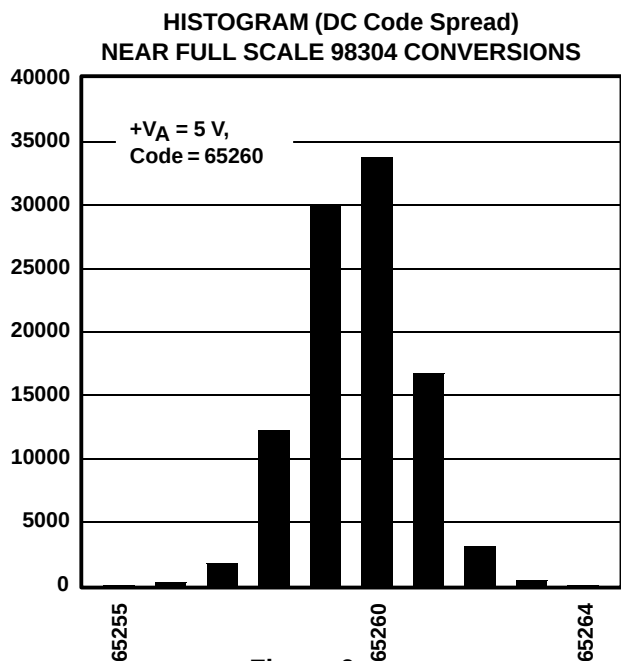


Figure 5. Detailed Timing for Read Cycles

# TYPICAL CHARACTERISTICS†



† At –40°C to 85°C, +V<sub>A</sub> = 5 V, +V<sub>BD</sub> = 5 V, REFIN = 4.096 V (internal reference used) and f<sub>sample</sub> = 1.25 MHz (unless otherwise noted)

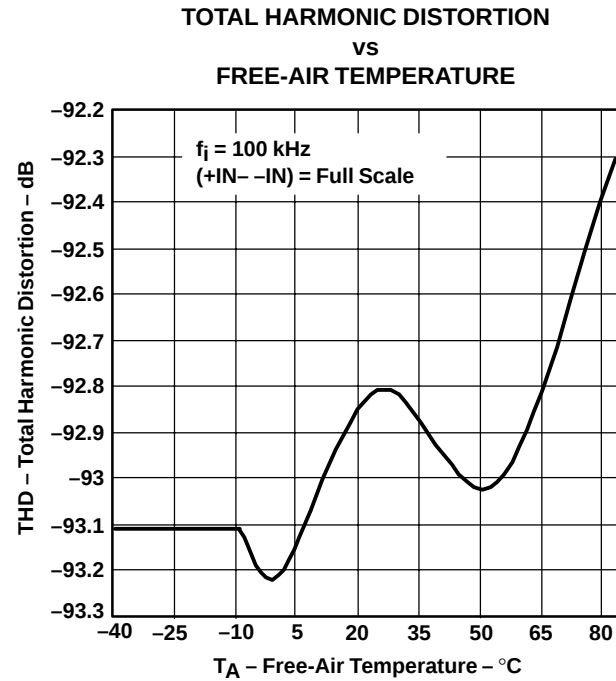


Figure 10

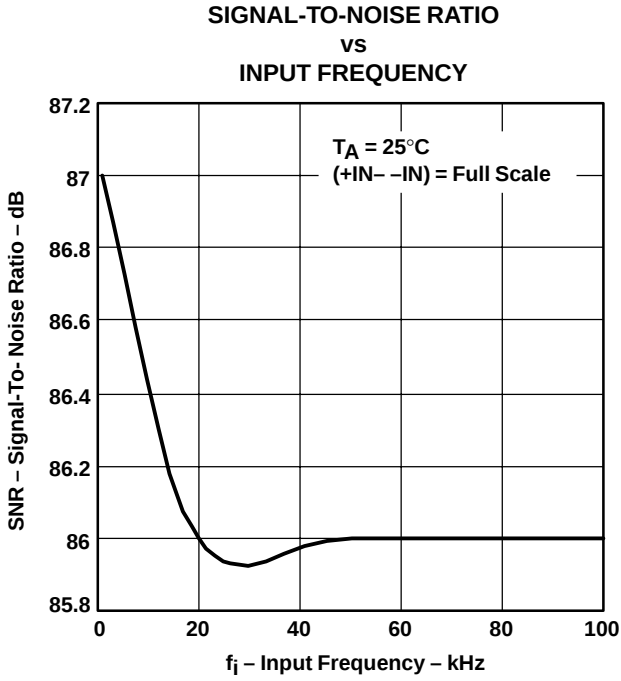


Figure 11

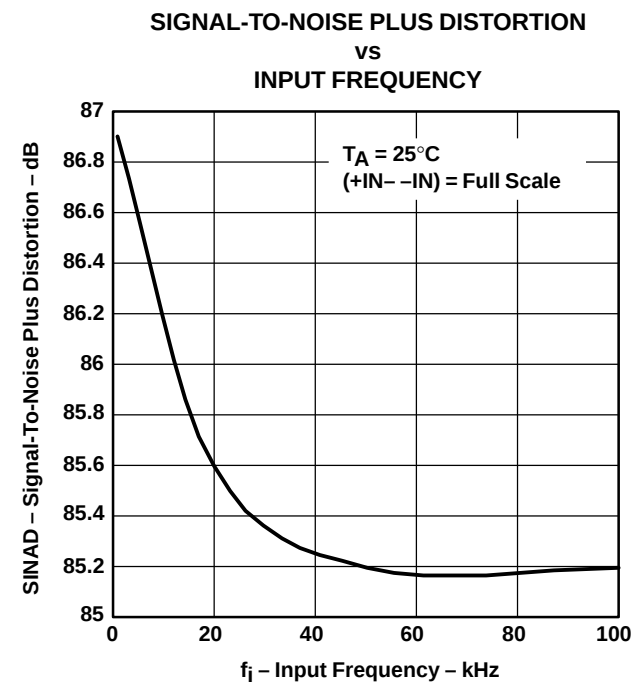


Figure 12

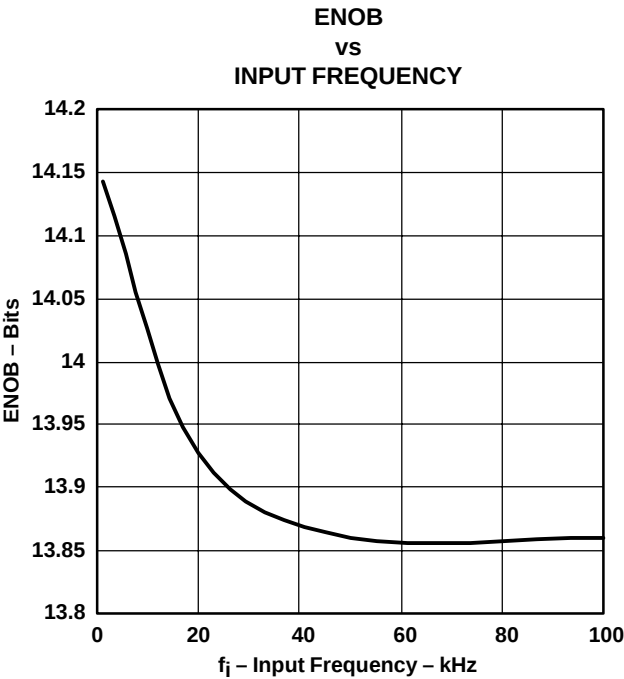


Figure 13

† At -40°C to 85°C, +VA = 5 V, +VBD = 5 V, REFIN = 4.096 V (internal reference used) and  $f_{\text{sample}} = 1.25 \text{ MHz}$  (unless otherwise noted)

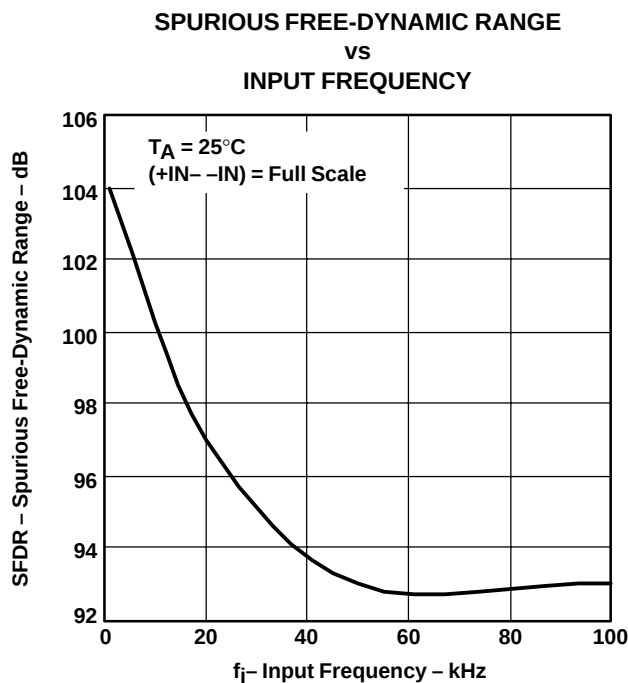


Figure 14

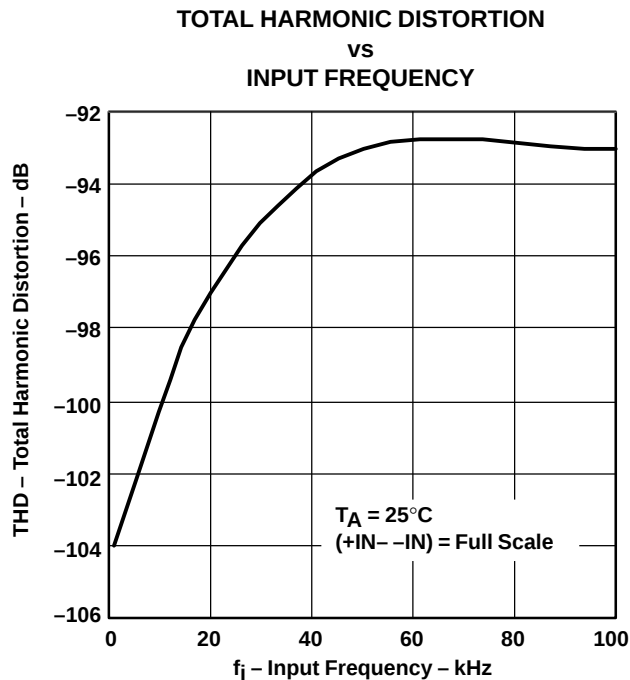


Figure 15

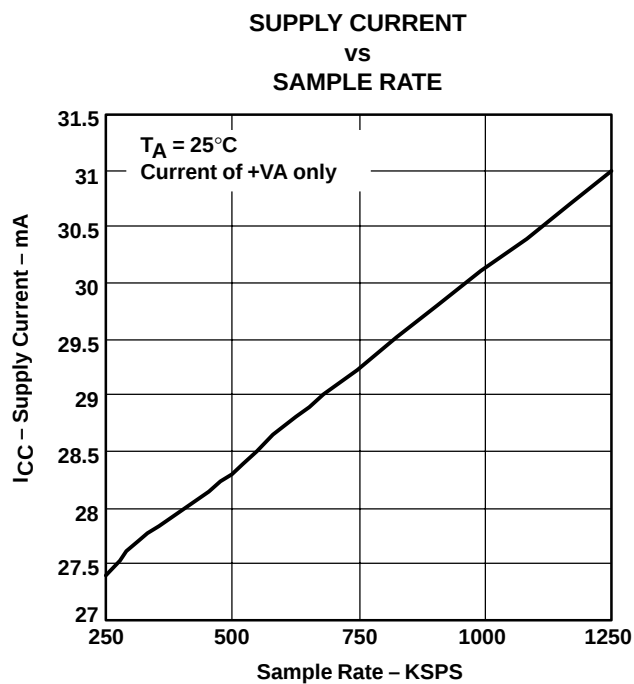


Figure 16

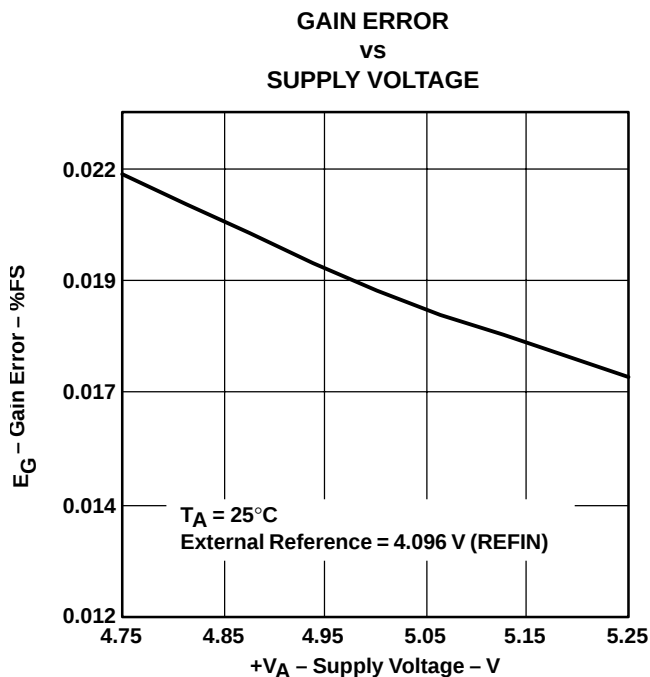


Figure 17

<sup>†</sup> At  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ , +V\_A = 5 V, +V\_BD = 5 V, REFIN = 4.096 V (internal reference used) and  $f_{\text{sample}} = 1.25$  MHz (unless otherwise noted)

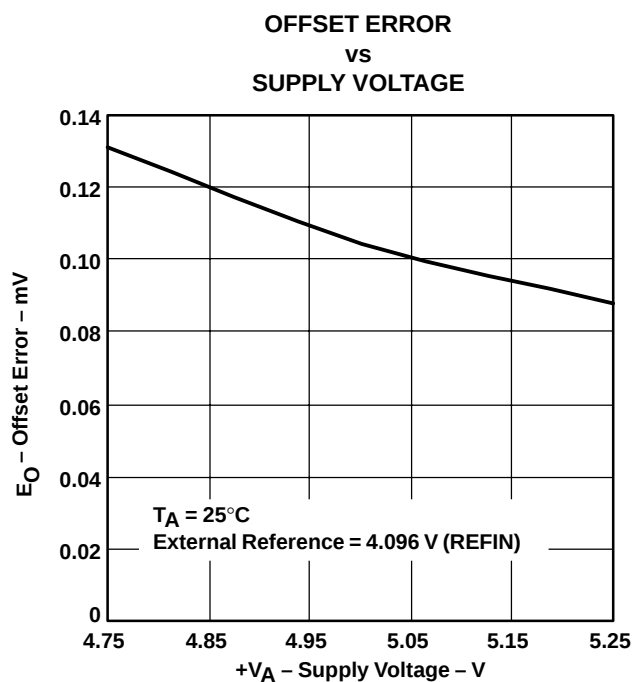


Figure 18

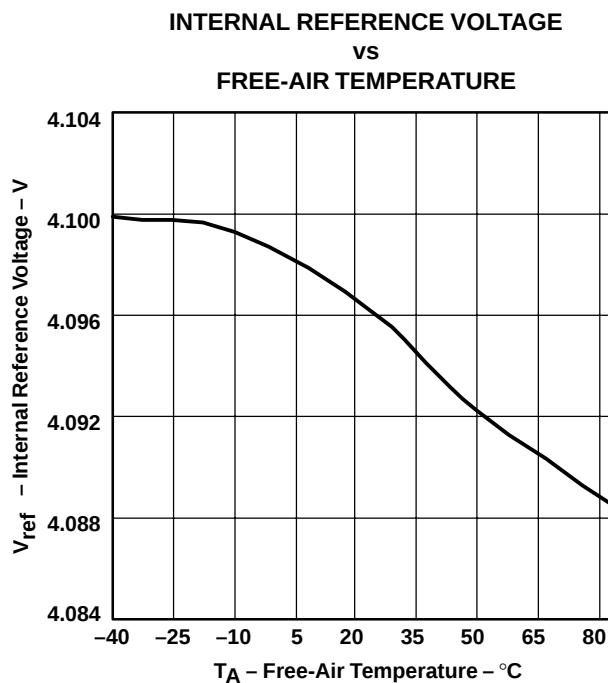


Figure 19

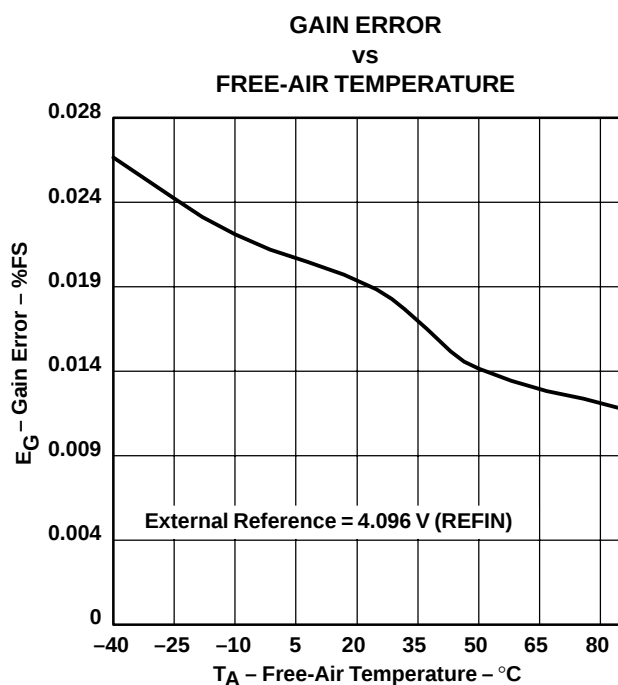


Figure 20

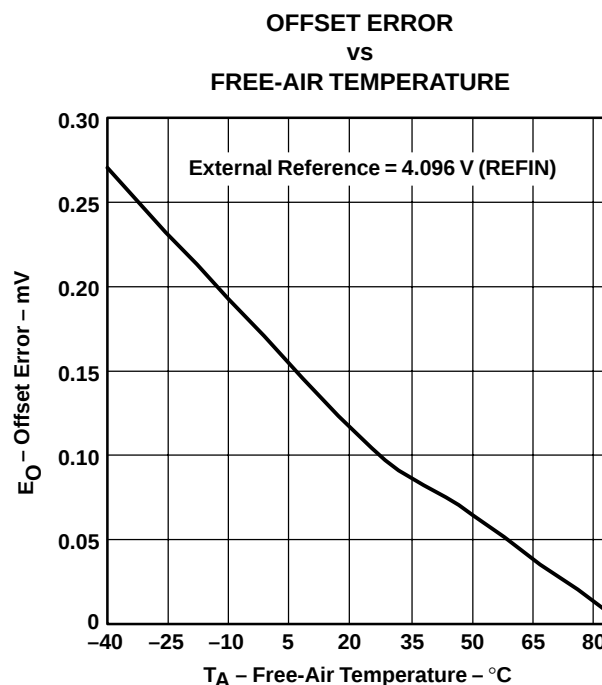


Figure 21

† At  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ ,  $+V_A = 5\text{ V}$ ,  $+V_{BD} = 5\text{ V}$ ,  $\text{REFIN} = 4.096\text{ V}$  (internal reference used) and  $f_{\text{sample}} = 1.25\text{ MHz}$  (unless otherwise noted)

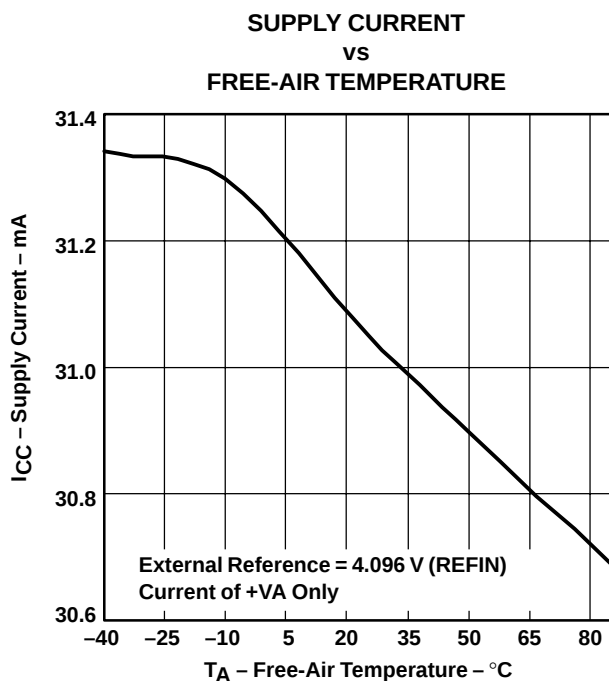


Figure 22

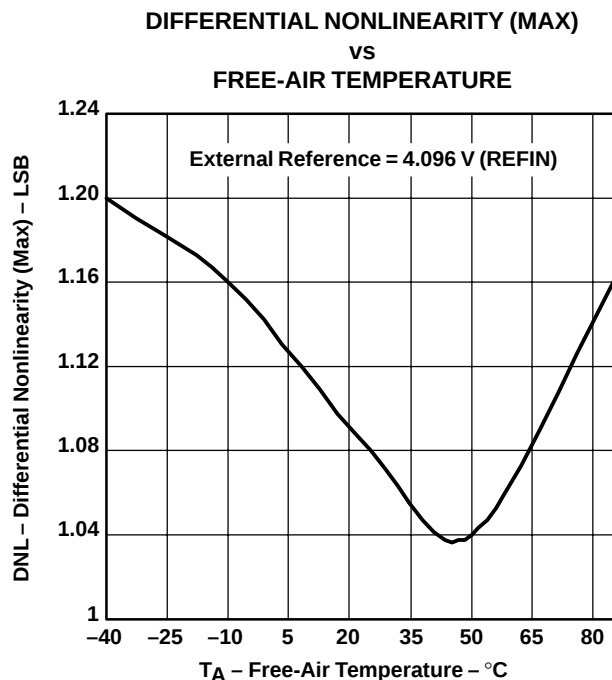


Figure 23

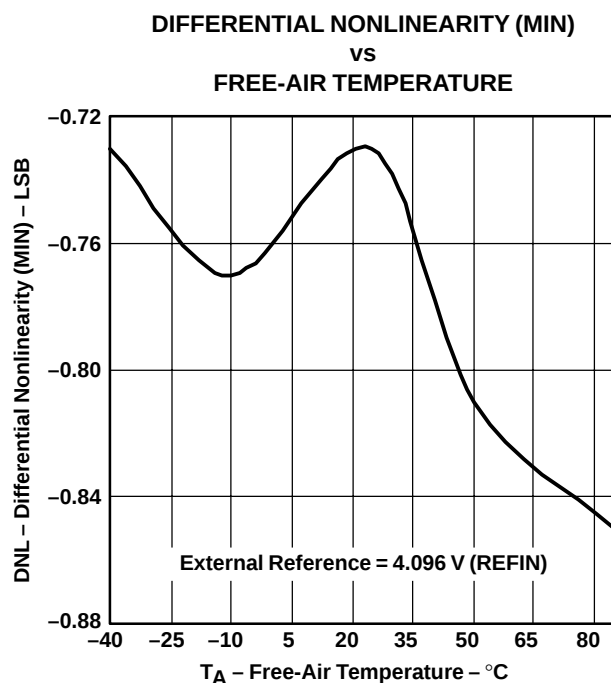


Figure 24

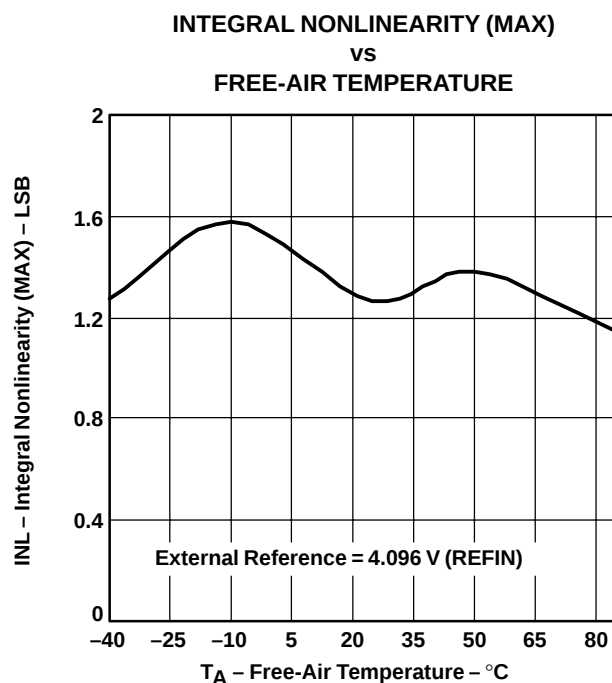


Figure 25

† At -40°C to 85°C, +VA = 5 V, +VBD = 5 V, REFIN = 4.096 V (internal reference used) and  $f_{\text{sample}} = 1.25$  MHz (unless otherwise noted)

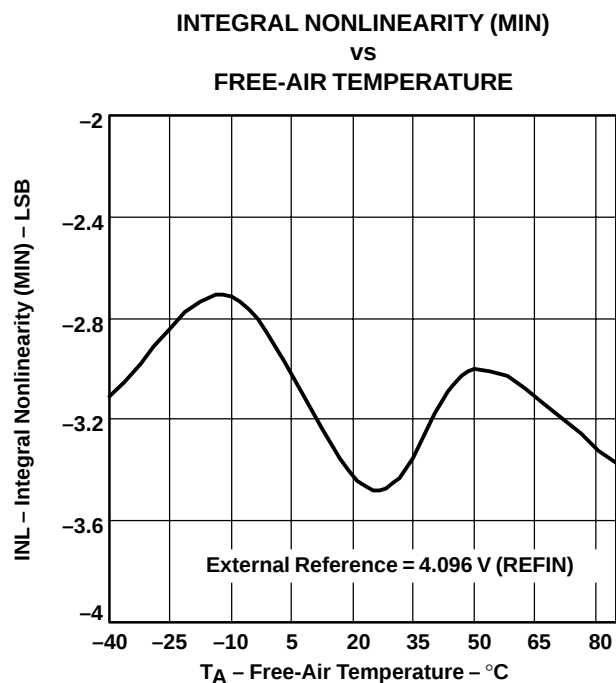


Figure 26

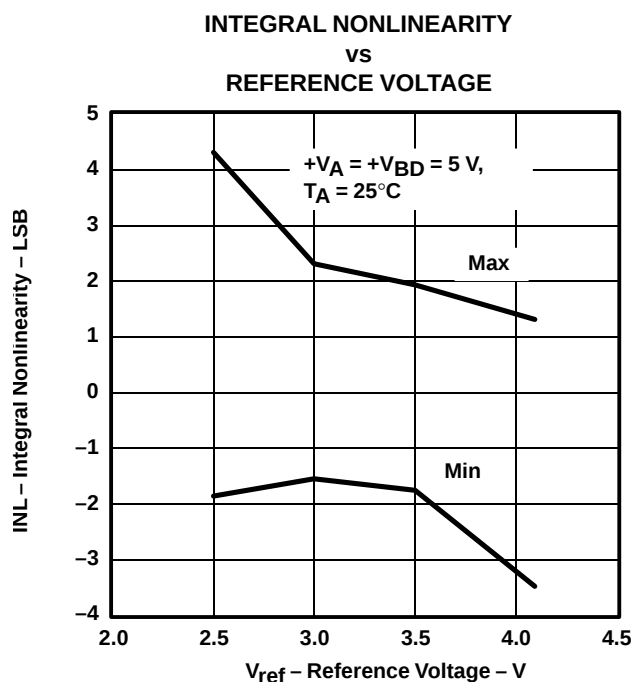


Figure 27

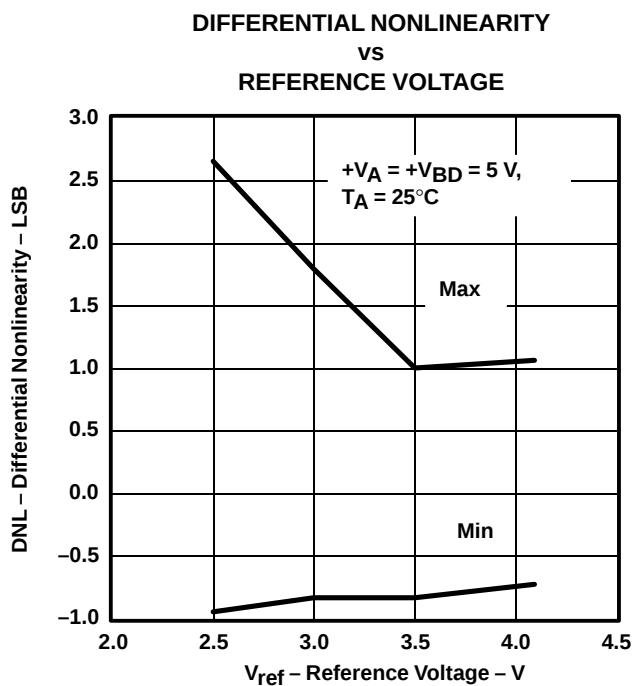
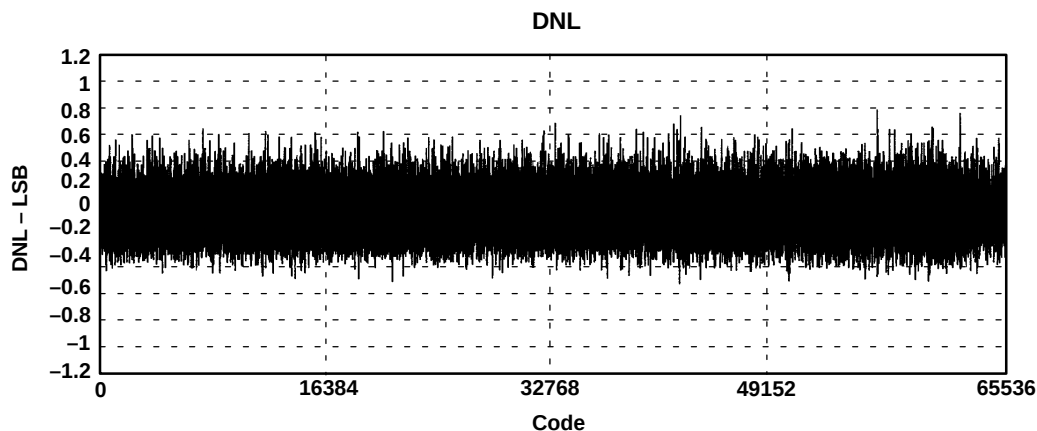


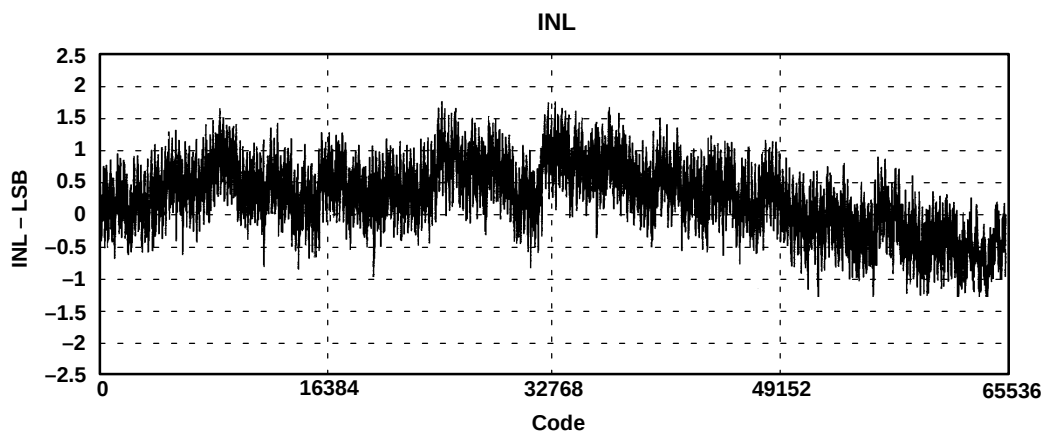
Figure 28

† At -40°C to 85°C, +VA = 5 V, +VBD = 5 V, REFIN = 4.096 V (internal reference used) and  $f_{\text{sample}} = 1.25$  MHz (unless otherwise noted)



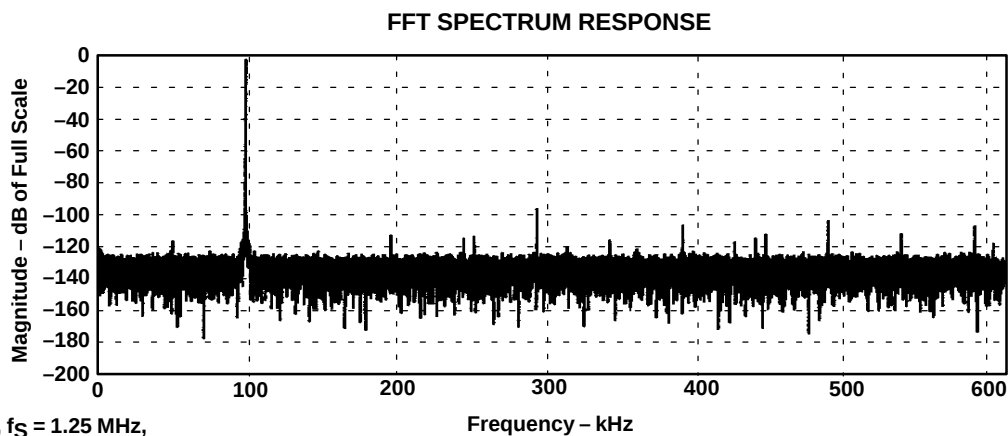
$T_A = 25^\circ\text{C}$ , External Reference = 4.096 V (REFIN)

Figure 29



$T_A = 25^\circ\text{C}$ , External Reference = 4.096 V (REFIN)

Figure 30



32768 Points,  $f_S = 1.25\text{ MHz}$ ,  
Internal Reference = 4.096 V (REFIN),  
 $T_A = 25^\circ\text{C}$ ,  $f_I = 100\text{ kHz}$ , (+IN – –IN) = Full Scale

Figure 31

<sup>†</sup> At  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ ,  $+V_A = 5\text{ V}$ ,  $+V_{BD} = 5\text{ V}$ , REFIN = 4.096 V (internal reference used) and  $f_{\text{sample}} = 1.25\text{ MHz}$  (unless otherwise noted)

## APPLICATION INFORMATION

### MICROCONTROLLER INTERFACING

#### ADS8401 to 8-Bit Microcontroller Interface

Figure 32 shows a parallel interface between the ADS8401 and a typical microcontroller using the 8-bit data bus.

The BUSY signal is used as a falling-edge interrupt to the microcontroller.

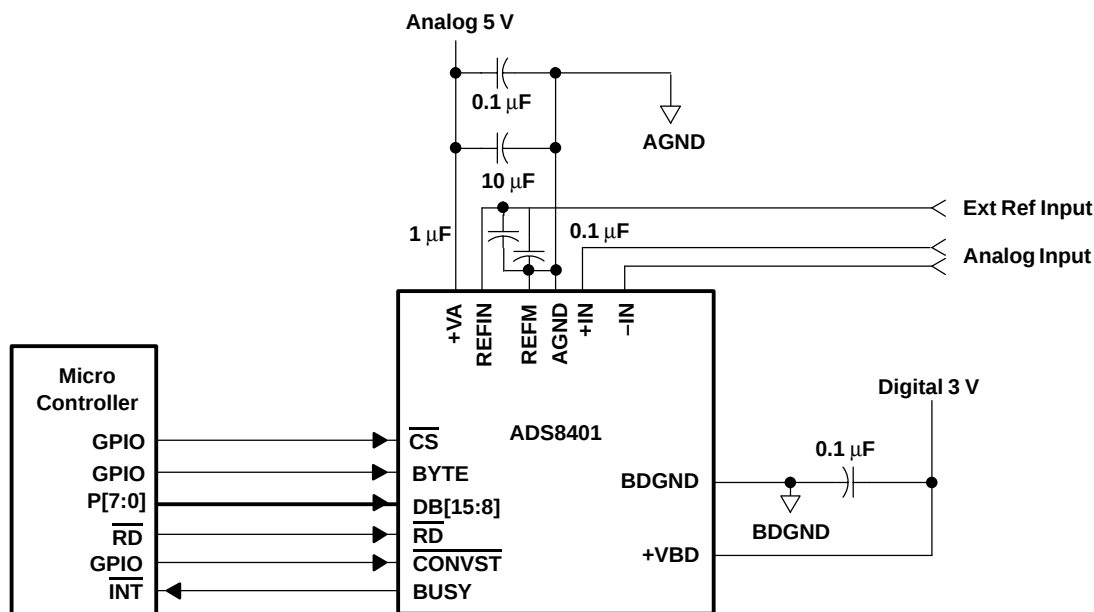


Figure 32. ADS8401 Application Circuitry (using external reference)

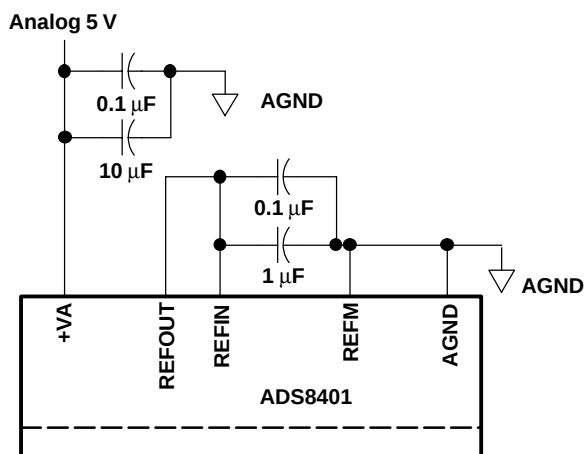


Figure 33. Use Internal Reference

## PRINCIPLES OF OPERATION

The ADS8401 is a high-speed successive approximation register (SAR) analog-to-digital converter (ADC). The architecture is based on charge redistribution, which inherently includes a sample/hold function. See Figure 32 for the application circuit for the ADS8401.

The conversion clock is generated internally. The conversion time of 610 ns is capable of sustaining a 1.25-MHz throughput.

The analog input is provided to two input pins: +IN and –IN. When a conversion is initiated, the differential input on these pins is sampled on the internal capacitor array. While a conversion is in progress, both inputs are disconnected from any internal function.

## REFERENCE

The ADS8401 can operate with an external reference with a range from 2.5 V to 4.2 V. A 4.096-V internal reference is included. When internal reference is used, pin 2 (REFOUT) should be connected to pin 1 (REFIN) with an 0.1  $\mu$ F decoupling capacitor and 1  $\mu$ F storage capacitor between pin 2 (REFOUT) and pins 47 and 48 (REFM) (see Figure 33). The internal reference of the converter is double buffered. If an external reference is used, the second buffer provides isolation between the external reference and the CDAC. This buffer is also used to recharge all of the capacitors of the CDAC during conversion. Pin 2 (REFOUT) can be left unconnected (floating) if external reference is used.

## ANALOG INPUT

When the converter enters the hold mode, the voltage difference between the +IN and –IN inputs is captured on the internal capacitor array. The voltage on the –IN input is limited between –0.2 V and 0.2 V, allowing the input to reject small signals which are common to both the +IN and –IN inputs. The +IN input has a range of –0.2 V to  $V_{ref} + 0.2$  V. The input span (+IN – (–IN)) is limited to 0 V to  $V_{ref}$ .

The input current on the analog inputs depends upon a number of factors: sample rate, input voltage, and source impedance. Essentially, the current into the ADS8401 charges the internal capacitor array during the sample period. After this capacitance has been fully charged, there is no further input current. The source of the analog input voltage must be able to charge the input capacitance (25 pF) to an 16-bit settling level within the acquisition time (150 ns) of the device. When the converter goes into the hold mode, the input impedance is greater than 1 G $\Omega$ .

Care must be taken regarding the absolute analog input voltage. To maintain the linearity of the converter, the +IN and –IN inputs and the span (+IN – (–IN)) should be within the limits specified. Outside of these ranges, the converter's linearity may not meet specifications. To minimize noise, low bandwidth input signals with low-pass filters should be used.

Care should be taken to ensure that the output impedance of the sources driving +IN and –IN inputs are matched. If this is not observed, the two inputs could have different settling time. This may result in offset error, gain error and linearity error which varies with temperature and input voltage.

## DIGITAL INTERFACE

### Timing And Control

See the timing diagrams in the specifications section for detailed information on timing signals and their requirements.

The ADS8401 uses an internal oscillator generated clock which controls the conversion rate and in turn the throughput of the converter. No external clock input is required.

Conversions are initiated by bringing the  $\overline{\text{CONVST}}$  pin low for a minimum of 20 ns (after the 20 ns minimum requirement has been met, the  $\overline{\text{CONVST}}$  pin can be brought high), while  $\overline{\text{CS}}$  is low. The ADS8401 switches from the sample to the hold mode on the falling edge of the  $\overline{\text{CONVST}}$  command. A clean and low jitter falling edge of this signal is important to the performance of the converter. The BUSY output is brought high after  $\overline{\text{CONVST}}$  goes low. BUSY stays high throughout the conversion process and returns low when the conversion has ended.

Sampling starts with the falling edge of the BUSY signal when  $\overline{CS}$  is tied low or starts with the falling edge of  $\overline{CS}$  when BUSY is low.

Both  $\overline{RD}$  and  $\overline{CS}$  can be high during and before a conversion with one exception ( $\overline{CS}$  must be low when  $\overline{CONVST}$  goes low to initiate a conversion). Both the  $\overline{RD}$  and  $\overline{CS}$  pins are brought low in order to enable the parallel output bus with the conversion.

## Reading Data

The ADS8401 outputs full parallel data in straight binary format as shown in Table 1. The parallel output is active when  $\overline{CS}$  and  $\overline{RD}$  are both low. There is a minimal quiet zone requirement around the falling edge of  $\overline{CONVST}$ . This is 100 ns prior to the falling edge of  $\overline{CONVST}$  and 40 ns after the falling edge. No data read should be attempted within this zone. Any other combination of  $\overline{CS}$  and  $\overline{RD}$  sets the parallel output to 3-state. BYTE is used for multiword read operations. BYTE is used whenever lower bits of the converter result are output on the higher byte of the bus. Refer to Table 1 for ideal output codes.

**Table 1. Ideal Input Voltages and Output Codes**

| DESCRIPTION                 | ANALOG VALUE                | DIGITAL OUTPUT STRAIGHT BINARY |          |
|-----------------------------|-----------------------------|--------------------------------|----------|
| FULL SCALE RANGE            | $V_{ref}$                   |                                |          |
| Least significant bit (LSB) | $V_{ref}/65536$             | BINARY CODE                    | HEX CODE |
| Full scale                  | $V_{ref} - 1 \text{ LSB}$   | 1111 1111 1111 1111            | FFFF     |
| Midscale                    | $V_{ref}/2$                 | 1000 0000 0000 0000            | 8000     |
| Midscale – 1 LSB            | $V_{ref}/2 - 1 \text{ LSB}$ | 0111 1111 1111 1111            | 7FFF     |
| Zero                        | 0 V                         | 0000 0000 0000 0000            | 0000     |

The output data is a full 16-bit word (D15–D0) on DB15–DB0 pins (MSB–LSB) if BYTE is low.

The result may also be read on an 8-bit bus for convenience. This is done by using only pins DB15–DB8. In this case two reads are necessary: the first as before, leaving BYTE low and reading the 8 most significant bits on pins DB15–DB8, then bringing BYTE high, the low bits (D7–D0) appear on pins DB15–D8.

These multiword read operations can be done with multiple active  $\overline{RD}$  (toggling) or with  $\overline{RD}$  tied low for simplicity.

| BYTE | DATA READ OUT |           |
|------|---------------|-----------|
|      | DB15–DB8      | DB7–DB0   |
| High | D7–D0         | All one's |
| Low  | D15–D8        | D7–D0     |

## RESET

$\overline{RESET}$  is an asynchronous active low input signal (that works independently of  $\overline{CS}$ ). Minimum  $\overline{RESET}$  low time is 20 ns. Current conversion will be aborted no later than 50 ns after the converter is in the reset mode. In addition, all output latches are cleared (set to zero's) after  $\overline{RESET}$ . The converter goes back to normal operation mode no later than 20 ns after  $\overline{RESET}$  input is brought high.

The converter starts the first sampling period 20 ns after the rising edge of  $\overline{RESET}$ . Any sampling period except for the one immediately after a  $\overline{RESET}$  is started with the falling edge of the previous BUSY signal or the falling edge of CS, whichever is later.

## POWER-ON INITIALIZATION

One  $\overline{RESET}$  pulse followed by three conversion cycles must be given to the converter after powerup to ensure proper operation. The next pulse can be issued once both +VA and +VBD reach 95% of the minimum required value.

## LAYOUT

For optimum performance, care should be taken with the physical layout of the ADS8401 circuitry.

As the ADS8401 offers single-supply operation, it is often used in close proximity with digital logic, microcontrollers, microprocessors, and digital signal processors. The more digital logic present in the design and the higher the switching speed, the more difficult it is to achieve good performance from the converter.

The basic SAR architecture is sensitive to glitches or sudden changes on the power supply, reference, ground connections and digital inputs that occur just prior to latching the output of the analog comparator. Thus, driving any single conversion for an n-bit SAR converter, there are at least n *windows* in which large external transient voltages can affect the conversion result. Such glitches might originate from switching power supplies, nearby digital logic, or high power devices.

The degree of error in the digital output depends on the reference voltage, layout, and the exact timing of the external event.

On average, the ADS8401 draws very little current from an external reference, as the reference voltage is internally buffered. If the reference voltage is external and originates from an op amp, make sure that it can drive the bypass capacitor or capacitors without oscillation. A 0.1- $\mu$ F bypass capacitor and a 1- $\mu$ F storage capacitor are recommended from pin 1 (REFIN) directly to pin 48 (REFM). REFM and AGND should be shorted on the same ground plane under the device.

The AGND and BDGND pins should be connected to a clean ground point. In all cases, this should be the analog ground. Avoid connections which are close to the grounding point of a microcontroller or digital signal processor. If required, run a ground trace directly from the converter to the power supply entry point. The ideal layout consists of an analog ground plane dedicated to the converter and associated analog circuitry.

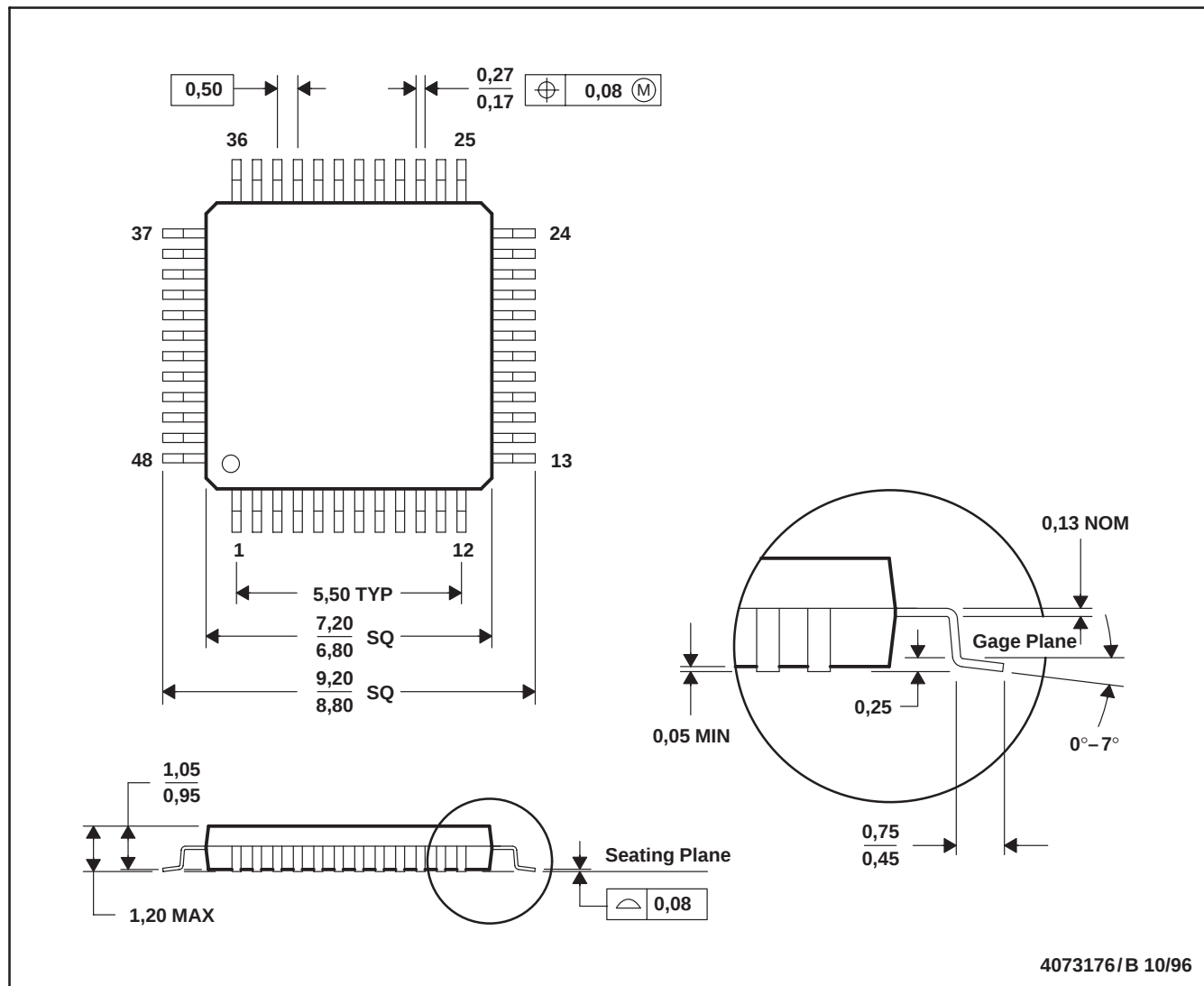
As with the AGND connections, +VA should be connected to a 5-V power supply plane or trace that is separate from the connection for digital logic until they are connected at the power entry point. Power to the ADS8401 should be clean and well bypassed. A 0.1- $\mu$ F ceramic bypass capacitor should be placed as close to the device as possible. See Table 2 for the placement of the capacitor. In addition, a 1- $\mu$ F to 10- $\mu$ F capacitor is recommended. In some situations, additional bypassing may be required, such as a 100- $\mu$ F electrolytic capacitor or even a Pi filter made up of inductors and capacitors—all designed to essentially low-pass filter the 5-V supply, removing the high frequency noise.

**Table 2. Power Supply Decoupling Capacitor Placement**

| POWER SUPPLY PLANE                                            | CONVERTER ANALOG SIDE                               | CONVERTER DIGITAL SIDE |
|---------------------------------------------------------------|-----------------------------------------------------|------------------------|
| SUPPLY PINS                                                   |                                                     |                        |
| Pin pairs that require shortest path to decoupling capacitors | (4,5), (8,9), (10,11), (13,15),<br>(43,44), (45,46) | (24,25), (34, 35)      |
| Pins that require no decoupling                               | 12, 14                                              | 37                     |

## PFB (S-PQFP-G48)

## PLASTIC QUAD FLATPACK



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MS-026

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| DSP              | <a href="http://dsp.ti.com">dsp.ti.com</a>                         | Broadband           | <a href="http://www.ti.com/broadband">www.ti.com/broadband</a>           |
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Mailing Address: Texas Instruments  
Post Office Box 655303 Dallas, Texas 75265

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